

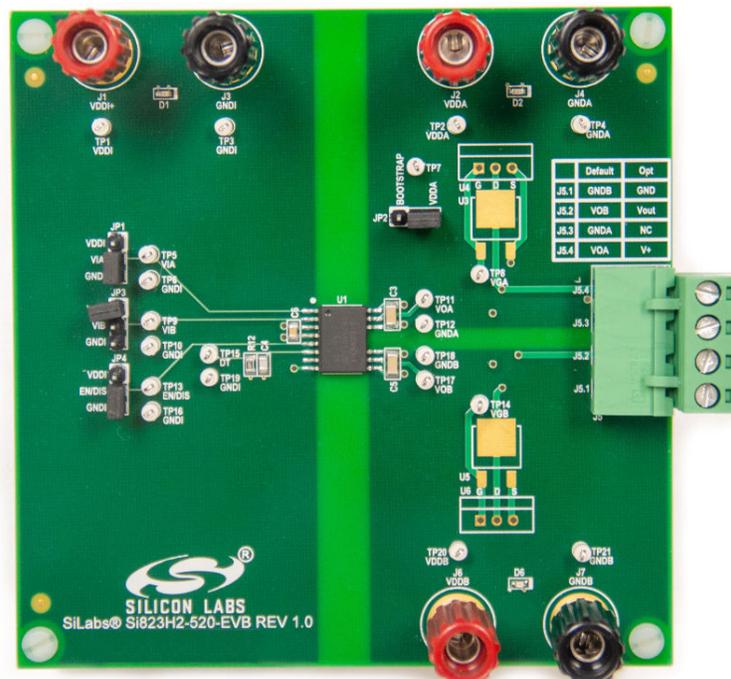
UG367: Si823Hx-EVB User's Guide

The Si823Hx isolated gate drivers are ideal for driving power switches used in a wide variety of power supply, inverter, and motor control applications, offering longer service life and dramatically higher reliability compared to opto-coupled gate drivers. The Si823Hx isolated gate drivers utilize Silicon Laboratories' proprietary silicon isolation technology supporting up to 5 kVRMS withstand voltage per UL1577 and VDE0884. This technology enables industry-leading common-mode transient immunity (CMTI), tight timing specifications, reduced variation with temperature and age, better part-to-part matching, and extremely high reliability. It also offers unique features, such as separate pull-up/down outputs, driver shutdown on UVLO fault, and precise dead time programmability. Driver outputs can be grounded to the same or separate grounds or connected to a positive or negative voltage. The TTL level compatible inputs with 800 mV hysteresis are available in individual control input (Si823H1/2/3/5/6/7 and Si82520) or PWM input (Si823H4/8) configurations. High integration, low propagation delay, small installed size, flexibility, and cost-effectiveness make the family ideal for a wide range of isolated MOSFET/IGBT/SiC/GaN gate drive applications.

The Si823Hx evaluation board allows designers to evaluate Silicon Lab's Si823Hx family of high CMTI performance ISOdrivers. The boards come populated with either the Si823H2, Si82520, or two Si823H9 version of the family. The board includes screw terminals for quick evaluation of the devices' key parameters and includes test points on each devices' pins to accommodate direct connection to the designer's end system. For more ISOdriver information, visit Silicon Labs web site at www.silabs.com/isolation. The product data sheet and numerous application notes can be referenced to help facilitate designs.

KIT CONTENTS

- Si823Hx-based evaluation board (Si823Hx-EVB) populated in one of the following configurations:
 - 1 - Si823H2, 2-input, 4 A, 5 kVrms High-Side/Low-Side ISOdriver
 - 1 - Si82520, 2-input, High Input Voltage, 4 A, 5 kVrms High-Side/Low-Side ISOdriver
 - 2 - Si823H9 1-input, 4 A, 5 kVrms Single Channel ISOdrivers



1. Required Equipment

The following equipment is required to demonstrate the evaluation board:

- One signal generator
- One dual dc power supply: 0–5 V and 0–15 V (or two single supplies)
- 1 oscilloscope (at least two channels)
- Assorted cables, leads and probes as necessary to connect equipment to EVB
- Si823Hx evaluation board (board under test)
- Si823Hx evaluation board user's guide (this document)

1.1 DC Supply Configuration

1. Set one supply to output 5 VDC.
2. Turn OFF the supply and connect the positive lead to VDDI (J1 pin1 or TP1).
3. Connect the negative lead to GNDI (J3 or TP3).
4. Turn ON the dc power supply.
5. Ensure that LED D1 turns on.
6. Ensure that the current draw is less than 25 mA. If it is larger, this indicates that either the board or Si823Hx has been damaged or the supply is connected backwards.
7. Set the other supply to output 15 VDC.
8. Turn OFF the supply and connect the positive lead to VDDA (J2 or TP2).
9. Connect the negative lead to GNDA (J4 or TP4).
10. Turn ON the supply.
11. Ensure that LED D2 turns on.
12. Ensure that the current draw is less than 100 mA. If it is larger, this indicates that either the board or Si823Hx has been damaged or the supply is connected backwards.

1.2 Function Generator

1. Turn ON the function generator with the output disabled.
2. Adjust its output to provide a 500 kHz, 0 to 5 V peak square wave (50 percent duty cycle) to its output.
3. Connect the output of the generator to VIA (TP5, ground on TP6).
4. Ensure a shunt is placed on TP3 between pins 2 and 3 (connects VIB to GND).
 - a. If the board being tested is Si823H2 or Si823H9, ensure a shunt is placed on JP4 between pins 1 and 2 to enable the device.
 - b. If the board being tested is an Si82520, ensure that the shunt on JP4 is between pins 2 and 3 to enable the device.
5. Enable the output of the waveform generator.

1.3 Oscilloscope Setup

To set up the oscilloscope, perform the following steps:

1. Set the scope to Trigger on CH1 and adjust the trigger level to approximately 2 V.
2. Set CH1 to 2 V per division and CH2 to 5 V per division
3. Adjust the seconds/division setting to 500 ns/division
4. Connect the scope channel 1 probe to VIA (TP5). Ground the probe to GNDI (TP6)
5. Connect Channel 2 probe to VOA (J5 pin 4 or TP11). Ground the probe to GNDA (J5 pin 3 or TP12)
6. Adjust the vertical position of each channel to properly view each channel as shown in the figure below

A 500 kHz square wave should display on Channel 1 of the scope for the input and a 15 V version should display on Channel 2, as shown in the following figure.

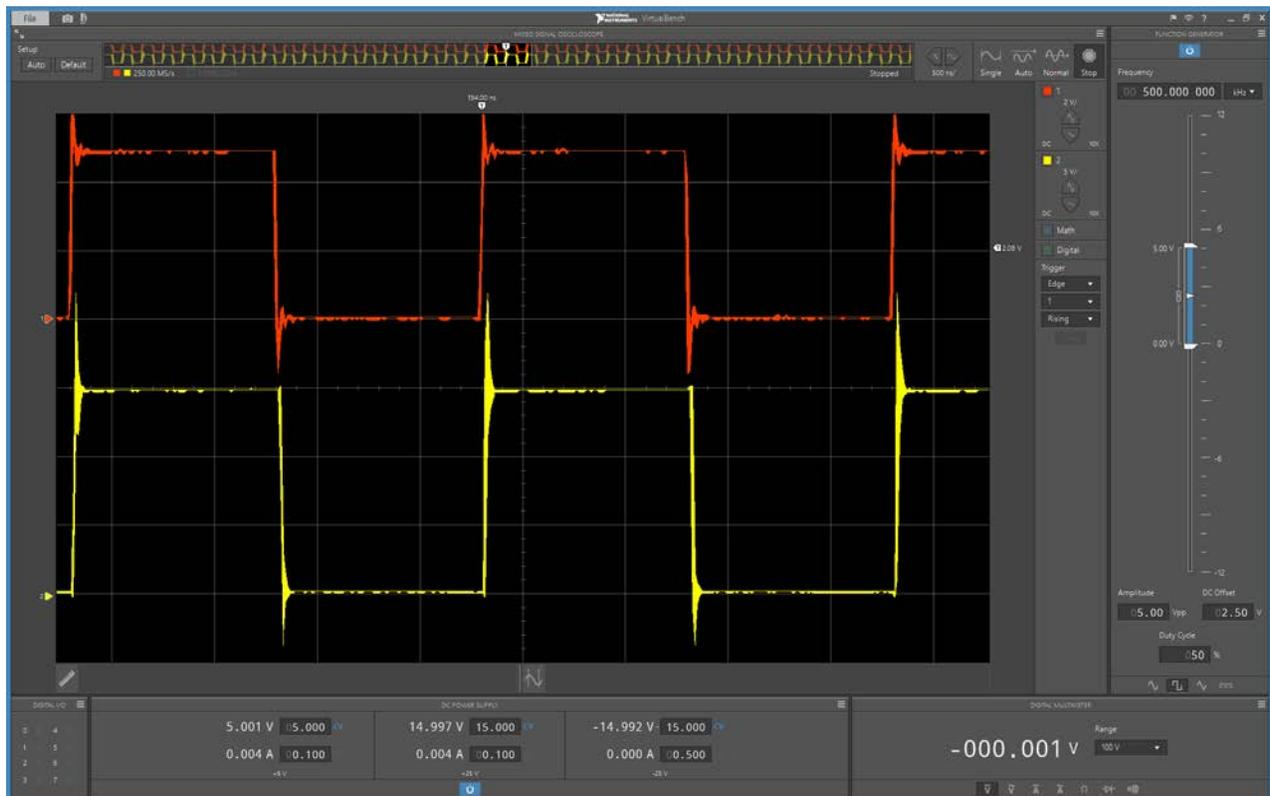


Figure 1.1. 500 kHz Square Wave

1.4 Repeat for Second Channel

1. Disable the function generator output.
2. Turn OFF the 15 V supply.
3. Disconnect 15 V supply from VDDA/GNDA.
4. Connect the 15 V supply to VDDB (J6 or TP20) and GNDB (J7 or TP21).
5. Move the Channel 2 scope probe to VOB (J5 pin 2 or TP18) and GNDB (J5 pin 1 or TP17).
6. Remove the shunt on JP3.
7. Move the function generator to VIB (TP9) and GNDI (TP10).
8. Place shunt on JP1 between Pins 2 and 3 (connects VIA to GNDI).
9. Turn ON the dc supply.
10. Ensure that LED D6 turns on.
11. Ensure that the current draw is less than 100 mA. If it is larger, this indicates that either the board or Si823Hx has been damaged or the supply is connected backwards.
12. Enable the function generator output.
13. The scope display should show both the input and output waveforms as before.

2. Built-In Options

The Si823Hx EVB comes from the factory configured to provide VOA, GNDA, VOB and GNDB signals out to the connector J5. This allows the evaluation of the Si823Hx drivers on their own. However, the board provides pads in which the customer can place components to build a half bridge for the Si823Hx to drive. This allows the customer to evaluate the Si823Hx driver in a manner that is closer to a real application.

To configure the board for a half bridge circuit, the following components must be removed:

- R3
- R9
- R11

Also, components for the following reference designators must be added:

- R7
- U3 or U4
- U5 or U6

The positions for U3, U4 provide an option for the customer to place a FET that is either a TO-220 package or a D-PAK package for the high side of the half-bridge. These two components are wired in parallel. They should not both be populated at the same time. The same is true for U5 and U6 for the low side device. The customer is free to place virtually any component in those positions to evaluate the Si823Hx driver in a circuit that resembles their intended application.

In addition to these options, there is a footprint for D4 and D5 as well as R4 and R8. This allows the customer to optimize the turn on and turn off currents for the FET's if they choose to do so. It should be noted that these diodes do not exist on the Si823H9-EVB. The Si823H9 driver provides separate pull-up and pull-down outputs making it unnecessary to use a diode. The resistors used for this purpose on the Si823H9-EVB are R4, R5, R8 and R10.

Furthermore, resistors R6 and R13 are footprints provided for the customer to add pull down resistors to turn off each FET should something prevent the VOA/VOB outputs from pulling the gate circuits low.

If these options are implemented, the pinout of J5 changes slightly. Pin 1 remains connected to GNDB and would be used for the half-bridge supply ground. Pin 2 becomes the output of the half-bridge. Pin 3 is no longer connected to anything. Pin 4 becomes the half-bridge positive supply.

Another option on the evaluation board is the setting of JP2. If a shunt is connected between pins 2 and 3 of JP2, the VDDA pin of the Si823Hx is connected to J2. This allows the customer to evaluate the Si823Hx driver with independent supplies. If a shunt is connected between pins 1 and 2 of JP2, then the VDDA pin is connected to diode D3 which is then connected to VDDB. This creates a boot strap supply for the A driver. In this configuration, capacitor C3 becomes the boot strap capacitor. It may be necessary to modify the value of C3 to optimize the performance of the boot strap supply. Please see our boot strap calculation tool online at <https://www.silabs.com/tools/Pages/bootstrap-calculator.aspx>.

Note: The Si823H9 and Si82520 evaluation boards are populated with dual drivers that have a high side/low side (HS/LS) operation. This means that if both VIA and VIB inputs are driven high, the device's overlap protection will force both VOA and VOB to a low state. However, the Si823H9-EVB is built with two single channel drivers. This means there is no overlap protection. If the customer populates the half-bridge components, they must make sure that both inputs are never driven high at the same time. Doing so will cause both FET devices to turn on at the same time and short circuit the bridge supply. This will almost certainly damage the FET devices and likely damage the Si823H9 devices as well.

3. Evaluation Board Schematics

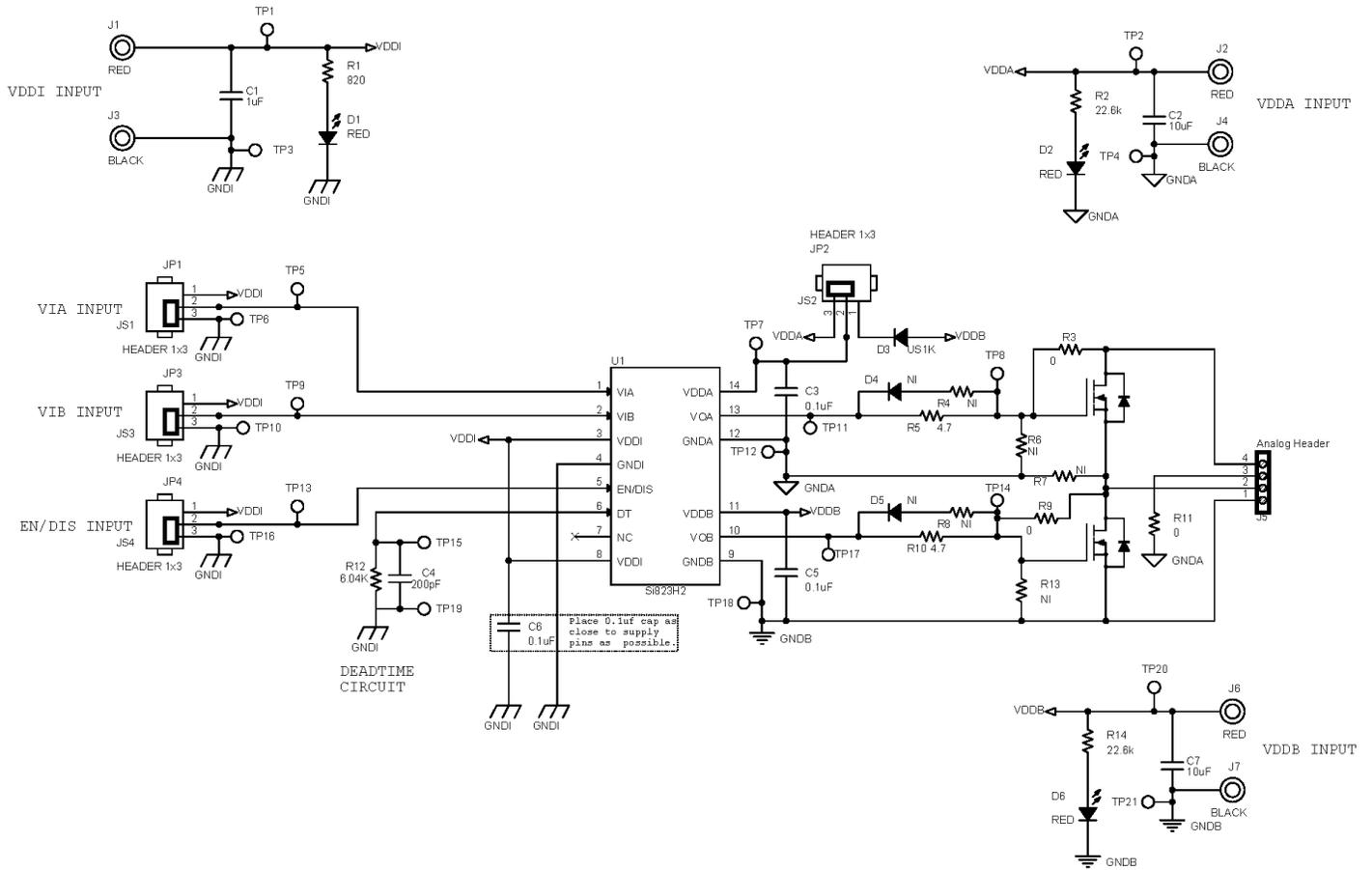


Figure 3.1. Si823H2 Evaluation Board Schematic

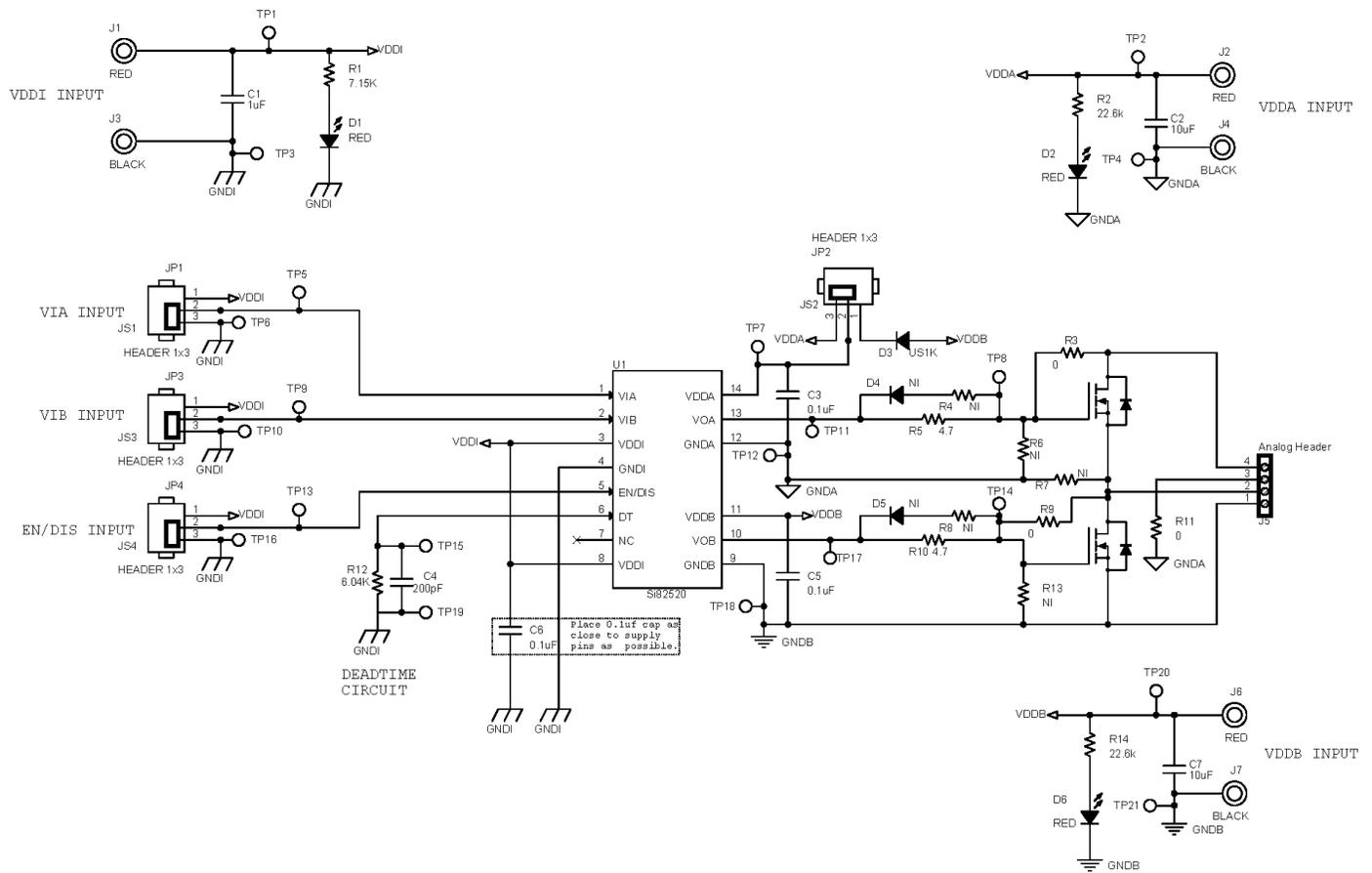


Figure 3.2. Si82520 Evaluation Board Schematic

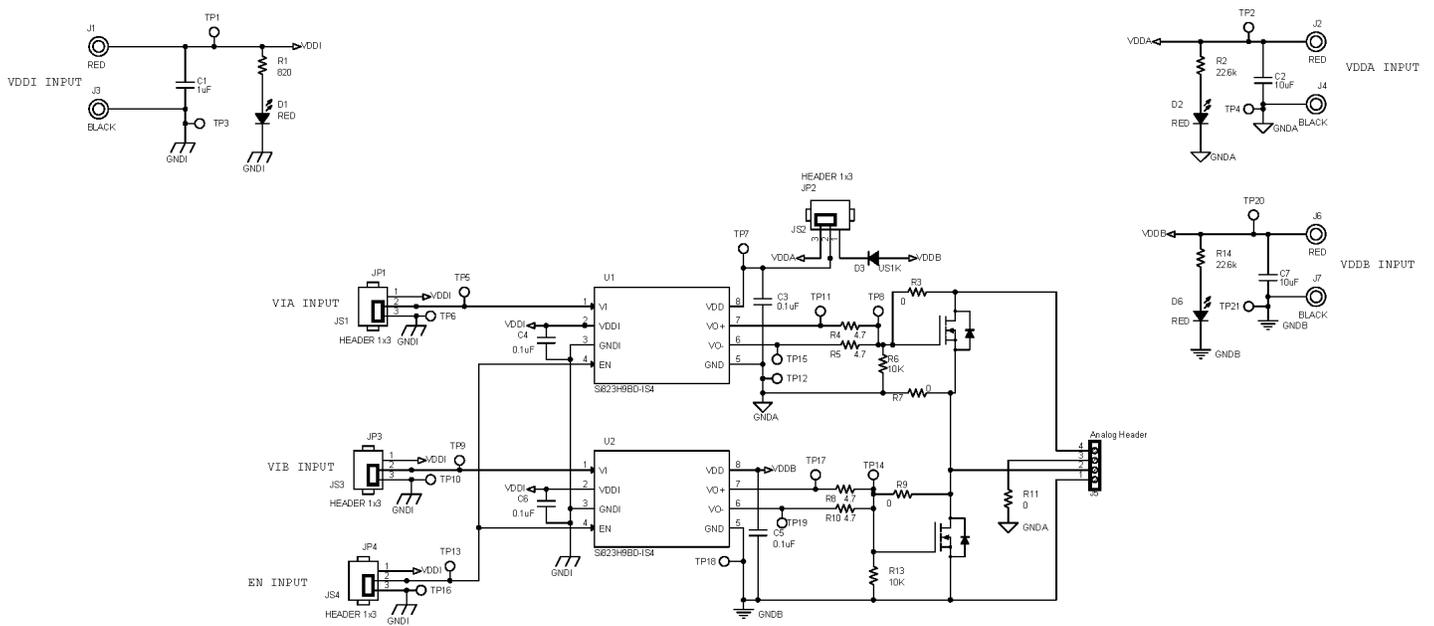


Figure 3.3. Si823H9 Evaluation Board Schematic

4. Evaluation Board Layouts

4.1 Si823H2-520 Layouts

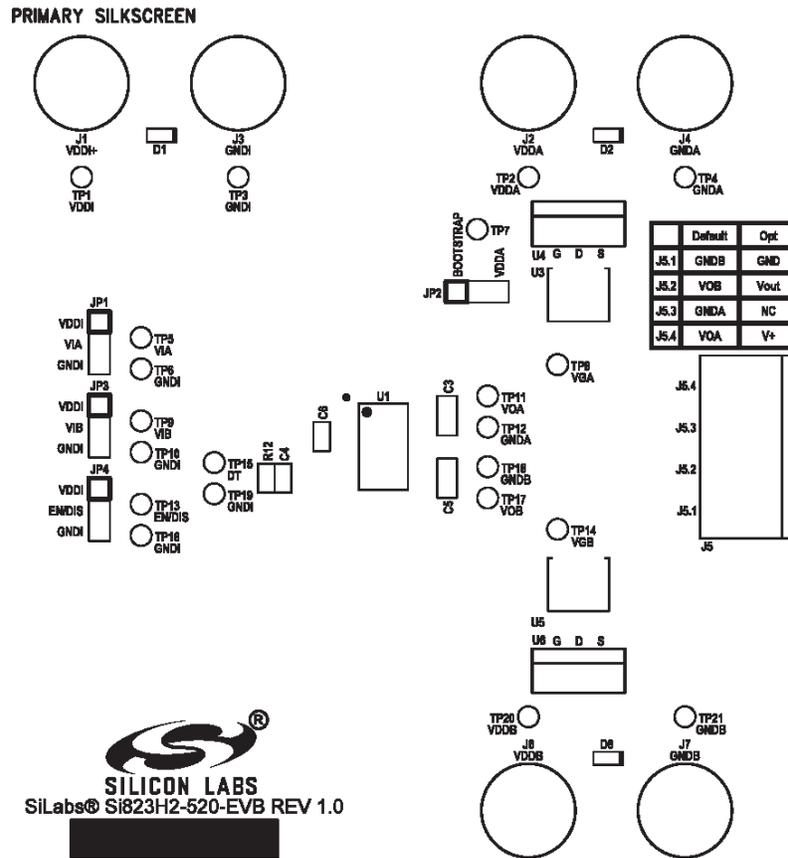


Figure 4.1. Si823H2-520 Primary Silk

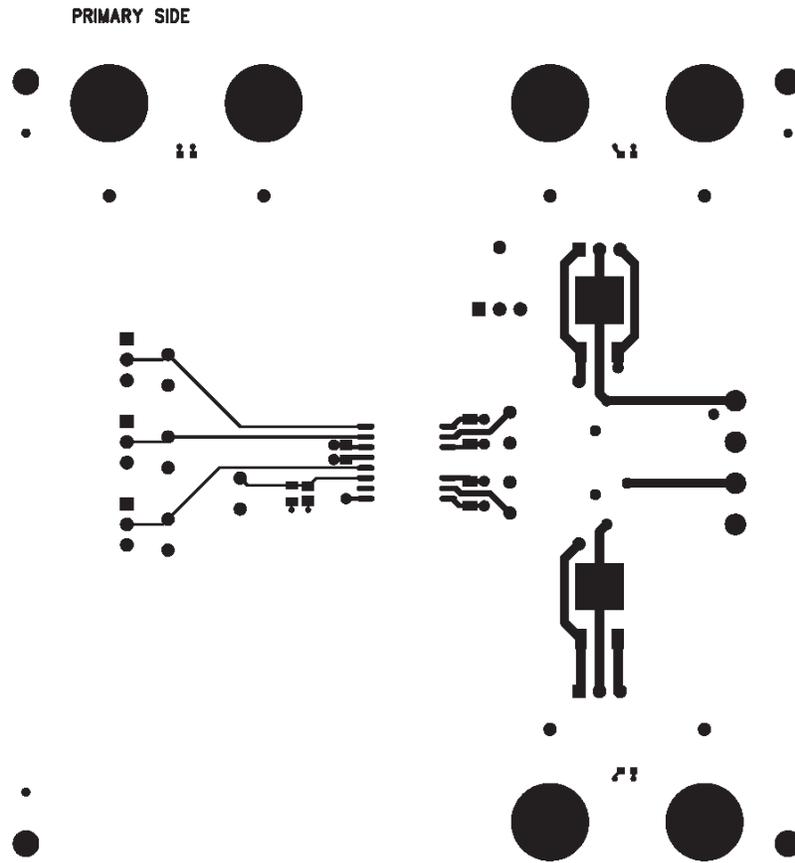


Figure 4.2. Si823H2-520 Primary Side

L02

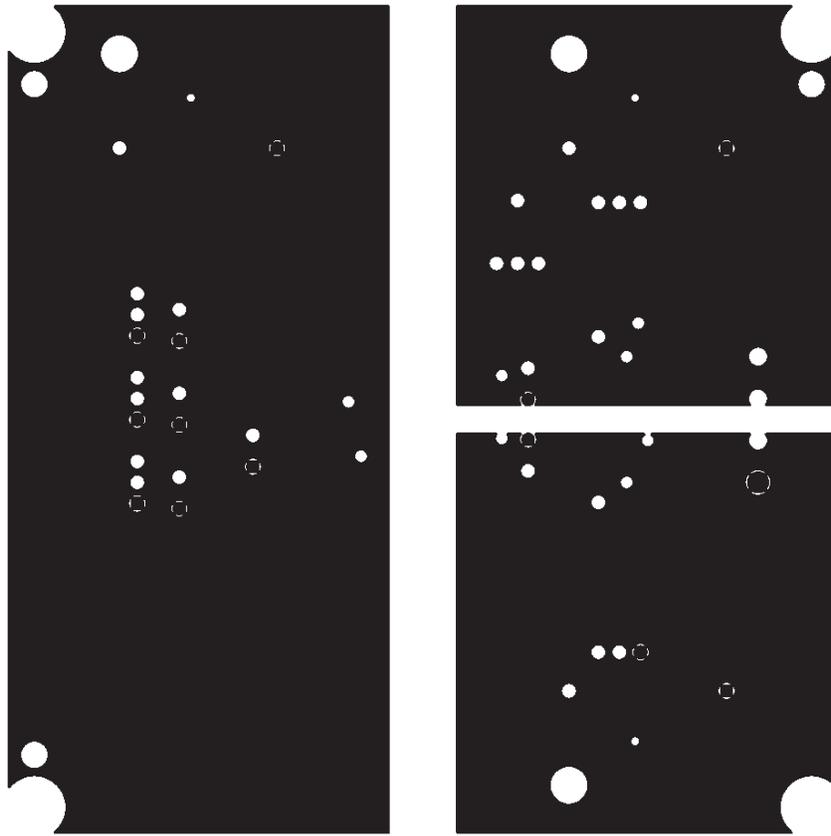


Figure 4.3. Si823H2-520 Ground

L03

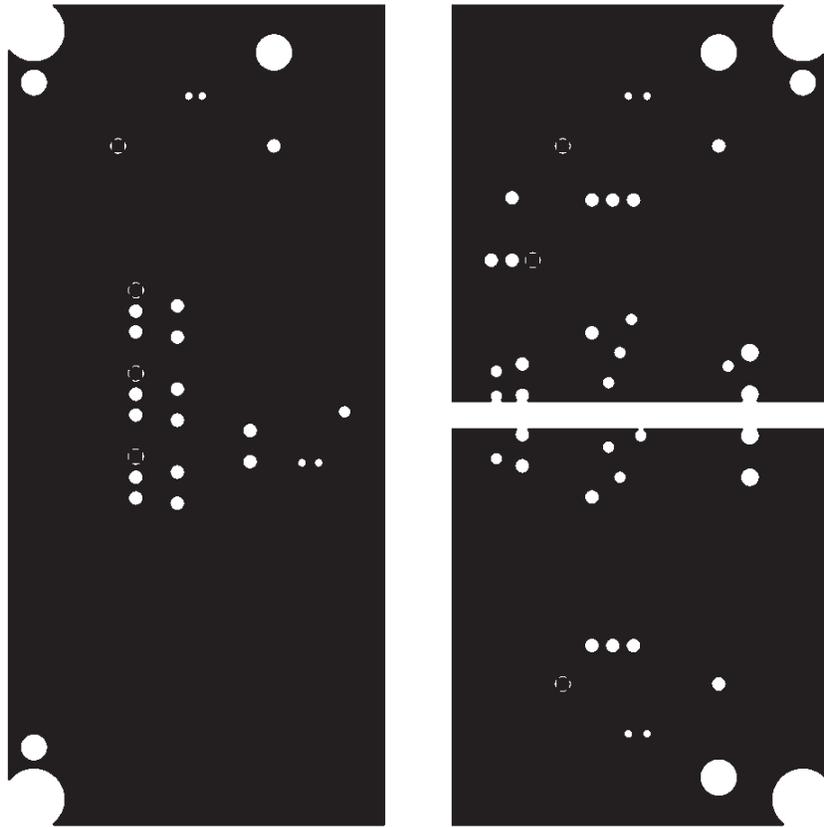


Figure 4.4. Si823H2-520 VDD

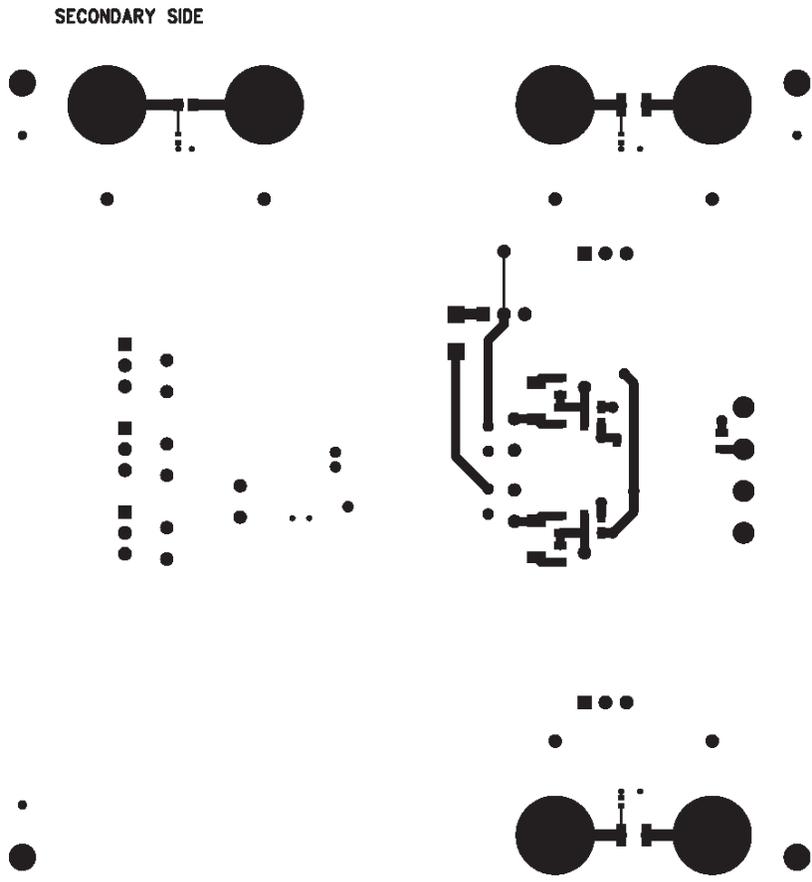


Figure 4.5. Si823H2-520 Secondary Side

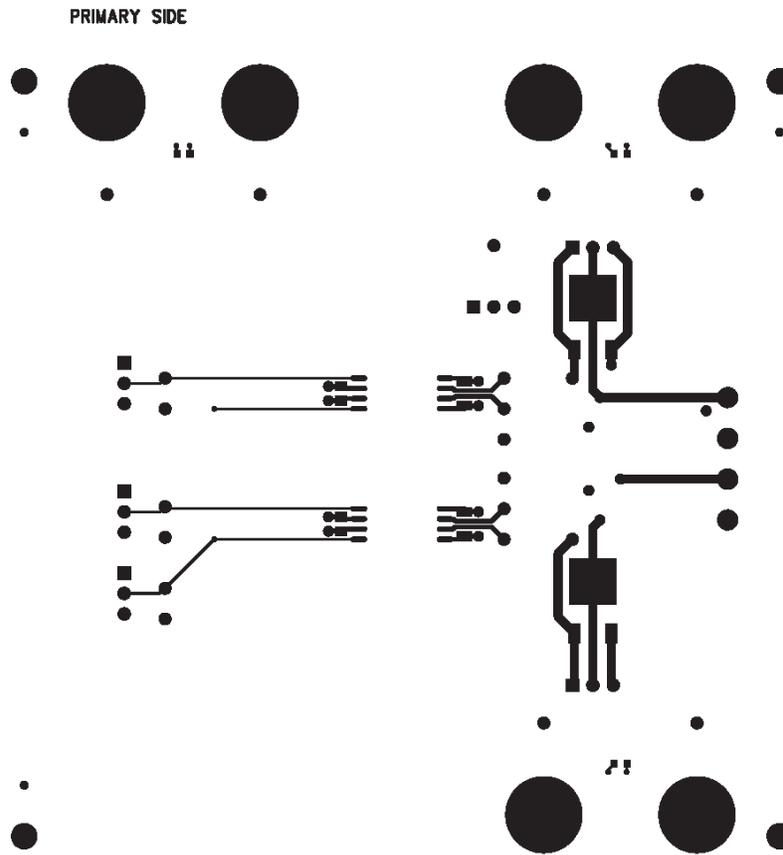


Figure 4.8. Si823H9 Primary Side

L02

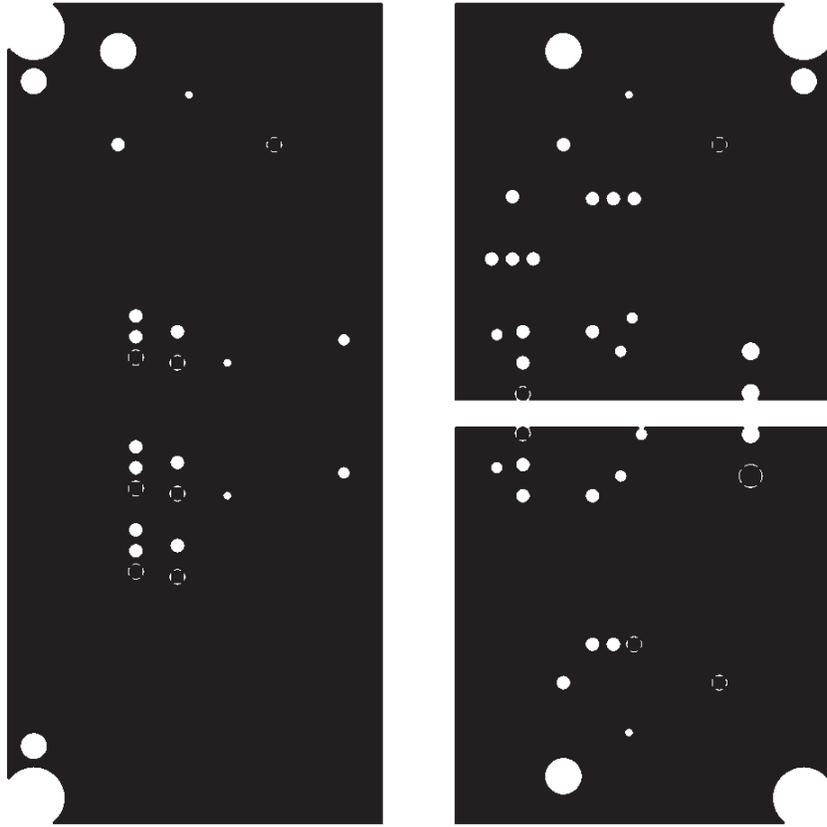


Figure 4.9. Si823H9 Ground

L03

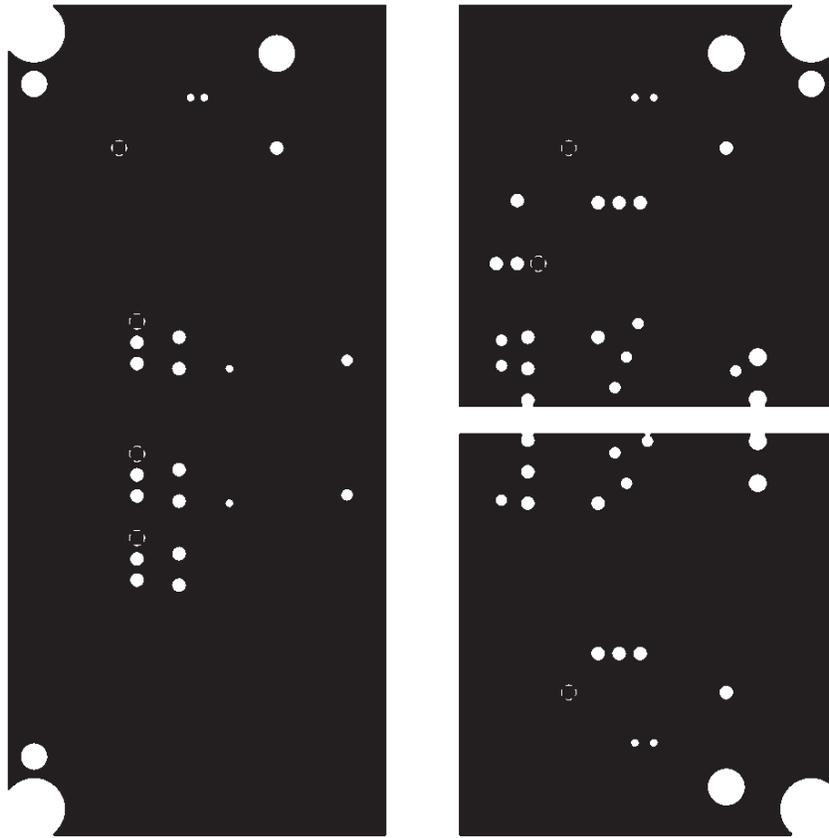


Figure 4.10. Si823H9 VDD

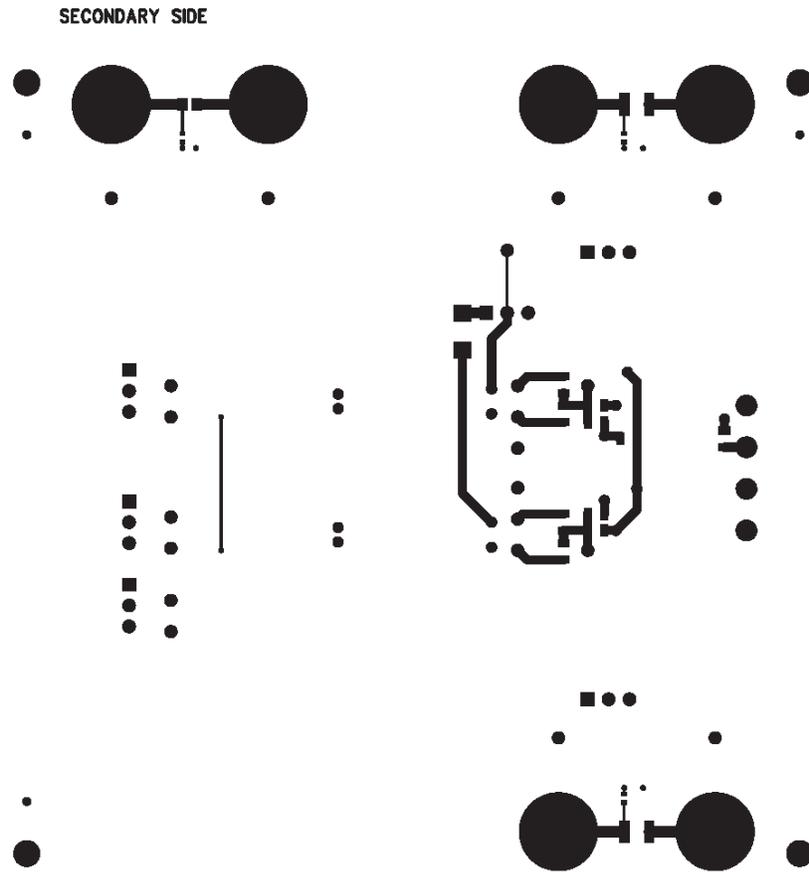


Figure 4.11. Si823H9 Secondary Side

SECONDARY SILKSCREEN

U2
U3

U5
U6

U4

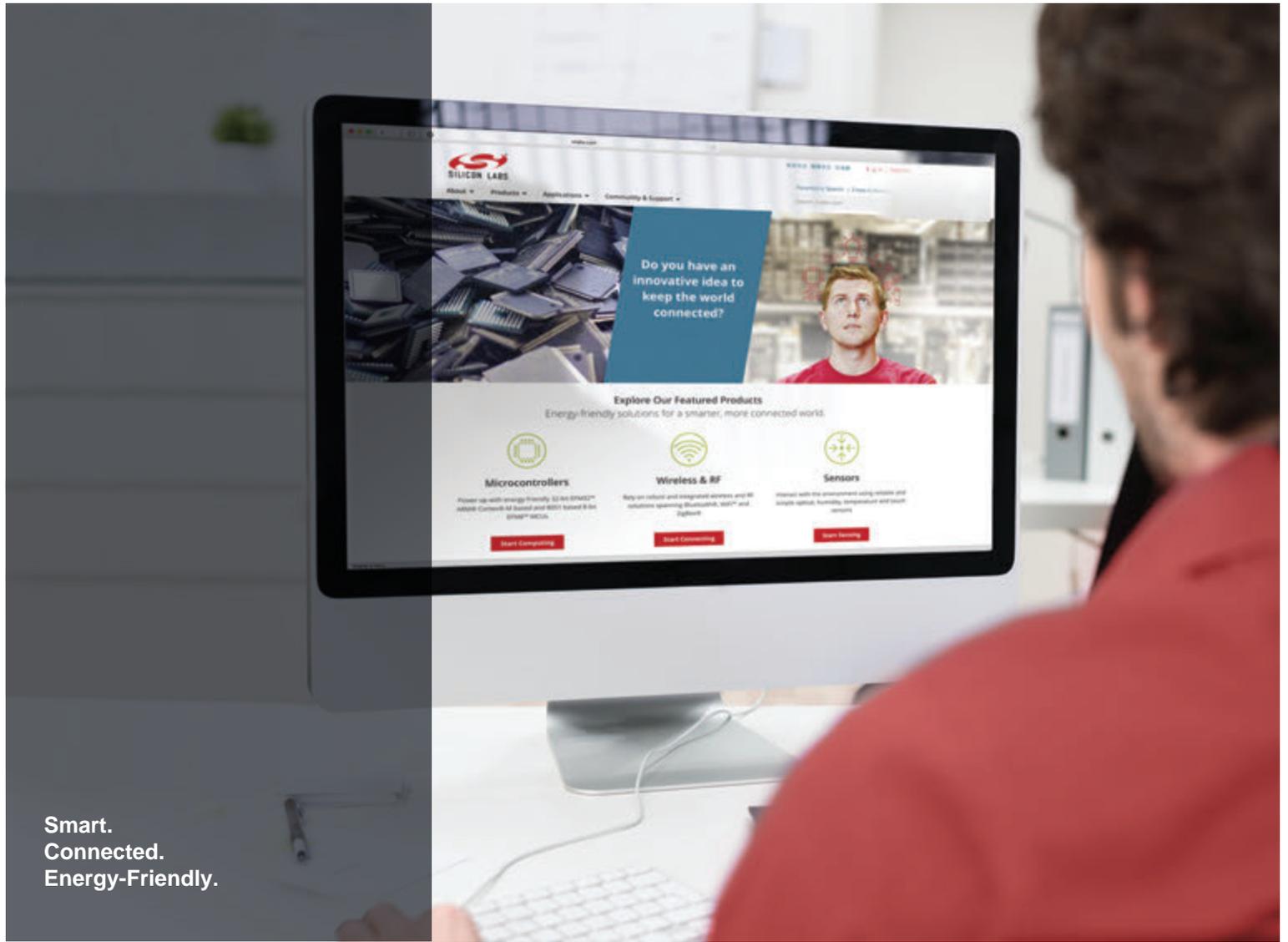
R1
R2
R3
R4

U7

R5
R6
R7

U8
U9

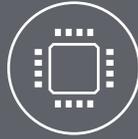
Figure 4.12. Si823H9 Secondary Silk



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